

How to change devices in the sample project for the DSP Library and the Security Library

Introduction

This document describes the procedures for migrating the driver and middleware sample code projects shown in the table below to other RL78 family devices.

Category	Driver and Middleware Name	Document Number	Target Device
DSP Library	RL78 Family RL78 Digital Signal Controller	R01AN1665	RL78/G16 ^{Note2}
	Library - Filter Note1		RL78/G22 ^{Note2}
	RL78 Family FFT Library Note1	R20AN0150	RL78/G16 ^{Note2}
			RL78/G22
Security Library	RL78 Family AES Library	R20AN0151	RL78/G16
			RL78/G22
			RL78/G24
	RL78 Family RSA Library	R20AN0326	RL78/G24
	RL78 Family SHA Hash Function Library	R20AN0211	RL78/G15
			RL78/G16
			RL78/G22
			RL78/G24
	RL78/G23 Unique ID Read Driver	R20AN0615	RL78/G22
			RL78/G24
	RL78 Family True Random Number	R20AN0617	RL78/G22
	Generator (TRNG) Software Driver		RL78/G24

Notes: 1. When migrating these libraries, use the sample project for the device with the same CPU core classification as the migration destination device.

- S2 Core : RL78/G15, RL78/G16

- S3 Core : RL78/G14, RL78/G22, RL78/G23, RL78/G24

For more information on CPU core classification, please refer to the following document.

- RL78 Family User's Manual: Software (R01US0015)

2. The sample projects using the CC-RL compiler in these libraries are not supported for RL78/G16 or RL78/G22 group devices.

The sample code included in the migration source project may not be usable as is because the ROM/RAM capacity of the migration destination device is not sufficient. In such cases, please change the sample code to fit into the ROM/RAM capacity of the migration destination device. See "2.1 Sample Code Size Adjustment" for an example of changing sample codes.

Target Device

RL78/G15, RL78/G16, RL78/G22, RL78/G24

When using this application note with other Renesas devices, careful evaluation is recommended after making modifications to comply with the alternate devices.



The versions of the development tools used in reviewing the procedures in this document are as follows.

RL78/G15

- CS+ for CC V8.08.00
- e2 studio 2022-10
- CC-RL V1.11.00
- LLVM for Renesas RL78 10.0.0.202209
- IAR Embedded Workbench for Renesas RL78 version 4.21.4
- IAR C/C++ Compiler for Renesas RL78 : 4.21.1.2409
- Smart Configurator for RL78 V1.4.0

RL78/G16

- CS+ for CC V8.09.00
- e² studio 2023-04
- CC-RL V1.12.00
- LLVM for Renesas RL78 10.0.0.202303
- IAR Embedded Workbench for Renesas RL78 version 4.21.4
- IAR C/C++ Compiler for Renesas RL78 : 4.21.1.2409
- Smart Configurator for RL78 V1.6.0

RL78/G22

- CS+ for CC V8.09.00
- e² studio 2023-01
- CC-RL V1.12.00
- LLVM for Renesas RL78 10.0.0.202209
- IAR Embedded Workbench for Renesas RL78 version 4.21.4
- IAR C/C++ Compiler for Renesas RL78 : 4.21.1.2409
- Smart Configurator for RL78 V1.5.0

RL78/G24

- CS+ for CC V8.09.00
- e² studio 2023-04
- CC-RL V1.12.00
- LLVM for Renesas RL78 10.0.0.202306
- IAR Embedded Workbench for Renesas RL78 version 4.21.4
- IAR C/C++ Compiler for Renesas RL78 : 4.21.1.2409
- Smart Configurator for RL78 V1.6.0



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1. Project Migration Procedure

Describes how to use each IDE's features to migrate a sample code project created for a specific RL78 family device to other RL78 family devices.

Open a migration source project in each IDE and change the device. Change source code, build settings, and debug settings according to the changed device.



Figure 1.1 Project Migration Procedure



1.1 CS+ for CC

Use the [Change Microcontroller] function to change the device.

If necessary, make a backup by manually copying a folder containing a migration source project file(.mtpj).

1.1.1 Opening a migration source project

(1) Click [Project] -> [Open Project] to display the Explorer for selecting a project file.



Figure 1.2 Opening a migration source project (1/2)



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(2) In the Explorer that appears, select a migration source project file and click [Open] to open the project.



Figure 1.3 Opening a migration source project (2/2)



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1.1.2 Changing the device

(1) Right-click on the Microcontroller item in the project tree and click [Change Microcontroller].



Figure 1.4 Changing the device (1/4)

(2) The message dialog appears confirming the project overwrite. Click [OK] to overwrite the migration source project.

Question(Q	0232002) ×	
2	Requires saving the current project to enable to restore the current project status after changing the microcontroller. Continue saving and processing?	
	OK Cancel Help	

Figure 1.5 Changing the device (2/4)



(3) After the migration source project is overwritten and saved, the Change Microcontroller dialog appears. Select the migration destination device (in this example, explained in R5F12068xSP) and click [OK].



Figure 1.6 Changing the device (3/4)

(4) Confirm that the Microcontroller item in the project tree has been changed to the migration destination device.



Figure 1.7 Changing the device (4/4)



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1.1.3 Device dependent changes

Change the source code and debug settings depending on the device.

If the sample project does not use the Smart Configurator, step (1) is not necessary.

(1) Changing source code

Refer to "2.2 Smart Configurator Change Procedure" to generate source code.

(2) Changing debug settings

Change the debug settings according to the operating environment.

For information on how to configure debug settings, please refer to the following document. — CS+ Integrated Development Environment User's Manual: RL78 Debug Tool (R20UT5136)



1.2 e² studio

Use the MCU migration feature to change the device.

When importing a project, you can use the copy project to workspace feature to make a backup.

1.2.1 Importing a migration source project

Import a migration source project into the migration destination workspace. If necessary, specify a new workspace directory or switch a workspace.

(1) Click [File] -> [Import] to open the project import window.

	Edit Source Refactor Navigate New Open File Open Projects from File System Recent Files	Alt+Shift+N	-
	Close Editor Close All Editors	Ctrl+W Ctrl+Shift+W	
	Save Save As Save All Revert	Ctrl+S Ctrl+S Ctrl+Shift+S	
Ð	Move Rename Refresh Convert Line Delimiters To	F2 F5	>
ès	Print Import Export	Ctrl+P	
	Properties	Alt+Enter	
	Switch Workspace Restart Exit	:	>

Figure 1.8 Importing a migration source project (1/4)



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(2) Select [General] -> [Existing Project to Workspace] and click [Next] to proceed to the next screen.

Import	223	×
elect		PKI
Create new projects from an archive file or directory.		
Select an import wizard:		
type filter text		
Y 🏷 General		
P Archive File		
28 Existing Projects into Workspace		
🔍 File System		
Preferences		
S Projects from Folder or Archive		
Rename & Import Existing C/C++ Project into Workspace		
Renesas CS+ Project for CA78K0R/CA78K0		
Renesas CS+ Project for CC-RX and CC-RL		
Renesas GitHub FreeRTOS (with IoT libraries) Project		
Sample Projects on Renesas Website		
> 🗁 C/C++		
> 🗁 Code Generator		
> 😕 Install		
> 🗁 Oomph		
> 😕 Run/Debug		
> 😕 Team		
> 🗁 TextMate		
? < Back Next > Finit	-	

Figure 1.9 Importing a migration source project (2/4)



(3) Select a migration source project and import it into the workspace. Click [Browse] and select a migration source project folder.

Check [Copy projects into workspace] and click [Finish].

		– 🗆 X
Import Projects		
Select a directory to sea	arch for existing Eclipse projects.	-
Select root directory:	C:\workspace\e2studio\workspace\e2studio\CCRL\sha_r	✓ Browse
O Select archive file:		∽ Browse
Projects:		
✓ sha_rl78_sim_sam	nple (C:\workspace\e2studio\workspace\e2studio\CCRL\sha	a_r Select All
		Deselect All
		Refresh
<		>
	ojects	>
Options Search for nested pr Copy projects into w Close newly importe Hide projects that al	ojects vorkspace ed projects upon completion	>
Options Search for nested pr Copy projects into w Close newly importe	ojects vorkspace ed projects upon completion ready exist in the workspace	> New
Options Search for nested projects into w Copy projects into w Close newly importe Hide projects that all Working sets	ojects vorkspace ed projects upon completion ready exist in the workspace	
Options Search for nested projects into w Copy projects into w Close newly importe Hide projects that all Working sets	ojects vorkspace ed projects upon completion ready exist in the workspace	New

Figure 1.10 Importing a migration source project (3/4)



How to change devices in the sample project for the DSP Library and the Security Library

(4) Confirm that the migration source project has been imported into the workspace.



Figure 1.11 Importing a migration source project (4/4)



How to change devices in the sample project for the DSP Library and the Security Library

1.2.2 Changing the device

(1) Select the project and click [Project] -> [Change Device] to display the device change screen.

Project Explorer ×		Open Project Close Project	1
> 🖻 sha_rl78_sim_sample [HardwareDebug]		Build All Build Configurations Build Project Build Working Set Clean Build Automatically	Ctrl+Alt+B > Ctrl+B >
		Build Targets	>
	e ²	C/C++ Index Update All Dependencies Change Device Change Toolchain Version	> Alt+D
	٩	C/C++ Project Settings Properties	Ctrl+Alt+P

Figure 1.12 Changing the device (1/5)



(2) Click the button to the right of [Target Device] and select the migration destination device (in this example, explained in R5F12068xSP).

Click [Next] to proceed to the next screen.

Refactoring				— 🗆	×
Change Device Select the new device fo	or sha_rl78_sim_sample	•			
Current Device: R7F100G Custom	iLGxFB				
Target Board: Custom					~
Target Device: R5F1206	8xSP			Unlock	Devices
?	< Back	Next >	Finish	Can	

Figure 1.13 Changing the device (2/5)



RL78 Family How to change devices in the sample project for the DSP Library and the Security Library

(3) You may be warned to back up your project, as changes to the device cannot be undone. Since the migration source project was copied to the workspace in "1.2.1 Importing a migration source project", no backup is required.

Click [Next] to proceed to the next screen.

Refactoring		×
Change Device		
Review the information provided in the list below. Click 'Next >' to view the next item of	or 'Finish'	
Found problems		\$ ∂
This change cannot be undone. Please make sure you backup this project before con	tinuing.	
No context information available		

Figure 1.14 Changing the device (3/5)



How to change devices in the sample project for the DSP Library and the Security Library

(4) Project changes is displayed. Click [Finish].

S Refactoring	– 🗆 X
Change Device	Bar
The following changes are necessary to perform the refactoring.	
Changes to be performed	🕆 🖓 👗 🔺
✓ ✓ Change Device for sha_rl78_sim_sample	
✓ ✓ Launch Configurations	
🖌 🖻 sha_rl78_sim_sample HardwareDebug	
> 🗹 🗟 Build Settings	
Project Files	
✓ Smart Configurator	
No preview available	
? < Back Next > Fir	nish Cancel

Figure 1.15 Changing the device (4/5)



RL78 Family How to change devices in the sample project for the DSP Library and the Security Library

(5) Open the project properties (right click on the project -> [Properties]) and confirm that [Current Device] under [C/C++ Build] -> [Settings] -> [Device] has been changed to the migration destination device.

Properties for sha	a_rl78_sim_sample	– 🗆 X
type filter text	Settings	♦ • ♦ •
 Resource Builders C/C++ Build 	Configuration: HardwareDebug [Active]	 Manage Configurations
Build Variables Environment Logging Settings Stack Analysis Tool Chain Edi > C/C++ General Project Natures Project Reference: Renesas QE Run/Debug Settir	Tool Settings Toolchain Device	fact Binary Parsers O Error Parsers
< >		Restore Defaults Apply
0		Apply and Close Cancel

Figure 1.16 Changing the device (5/5)



How to change devices in the sample project for the DSP Library and the Security Library

1.2.3 Device dependent changes

Change the source code and debug settings depending on the device.

If the sample project does not use the Smart Configurator, step (1) is not necessary.

(1) Changing source code

Refer to "2.2 Smart Configurator Change Procedure" to generate source code.

(2) Changing debug settings

Change the debug settings according to the operating environment.

For information on how to configure debug settings, please refer to the following document.

— e² studio Integrated Development Environment User's Manual: Getting Started Guide (R20UT4819)



1.3 IAR Embedded Workbench for Renesas RL78

Change the device in the project options settings.

If necessary, make a backup by manually copying a folder containing a migration source project file(.ewp).

1.3.1 Opening a migration source project

(1) Click [Project] -> [Add Existing Project] to display the Explorer for selecting a project file.



Figure 1.17 Opening a migration source project (1/2)



How to change devices in the sample project for the DSP Library and the Security Library

(2) In the Explorer that appears, select a migration source project file, and click [Open] to open the project.

File Edit View Project Emulator Tools Win	ndow H	lelp	
🗄 🗅 🖻 🖬 🔚 🗶 🛍 🛅 🖢 C 🗌			
Workspace	•	φ×	
Debug		\sim	
Files	•	•	
🗆 🌒 sha_rl78_sim_sample - Debug *	1		
├-曰 🛋 libsrc			
🖵 🖬 sha			
│			
└─⊞ 💼 src		•	
├			
🔰 🖵 🗐 smc_gen 🛛 🔹 🕚			
– ⊞ 🗟 main.c		•	
⊨ 🖬 main.h			
L-📮 💼 Output			
🖵 🗋 sha_rl78_sim_sample.out			
sna_n/v_snn_sample.out			

Figure 1.18 Opening a migration source project (2/2)

If the following screen appears when opening a project, click [Yes].

larldePm	\times
The project file 'sha_rl78_sim_sample.ewp' is in an old format. Would you like to convert it for use with this version? (The converted project will not work with older versions of EW, but a backup copy of the original file	will be made.)
Yes No	

Figure 1.19 Confirmation of project file conversion



How to change devices in the sample project for the DSP Library and the Security Library

1.3.2 Changing the device

(1) Right-click on the project and click [Options] to open the options screen.



Figure 1.20 Changing the device (1/2)



RL78 Family How to change devices in the sample project for the DSP Library and the Security Library

(2) Open [General Options] -> [Target] and click the button to the right of [Device] to select the migration destination device (in this example, explained in [RL78 - R5F12068]). Confirm that the migration destination device is selected and click [OK].

Category: General Options Static Analysis	
C/C++ Compiler Assembler Output Converter	Library Options 2 Stack/Heap MISRA-C:2004 MISRA-C:1998 Target Output Library Configuration Library Options 1
Custom Build Build Actions Linker Debugger COM Port E1 E2 E20 E2 Lite / E2 On-board EZ-CUBE EZ-CUBE EZ-CUBE Simulator TK	Device RL78 - R5F1 2068 Code model Near Use far runtime library calls Data model Near Near Near constant location Override default addresses Start address: End address: Mirror ROM 0

Figure 1.21 Changing the device (2/2)



How to change devices in the sample project for the DSP Library and the Security Library

1.3.3 Device dependent changes

Change source code, build settings, and debug settings depending on the device.

If the sample project does not use the Smart Configurator, step (1) is not necessary.

(1) Changing source code

Refer to "1.3.4 Smart Configurator Settings" to generate source code.

(2) Changing build settings

Change the stack size according to the migration destination device. On the options screen, open [General Options] -> [Stack/Heap] and change the [Stack size (bytes)].

Category: General Options Static Analysis C/C++ Compiler Assembler Output Converter Custom Build Build Actions Linker Debugger COM Port E1 E2 E20 E2 Lite / E2 On-board EZ-CUBE EZ-CUBE Simulator TK	F F	de default eap size (by uge:	Stack/Heap	y Configuration MISRA-C:2004 Stack size (bytes) 2048	Library Options 1 MISRA-C:1998
--	--------	------------------------------------	------------	---	-----------------------------------

Figure 1.22 Change stack size

(3) Changing debug settings

Change the debug settings according to the operating environment.

For more information on how to configure debug settings, please refer to the relevant documentation from IAR.



1.3.4 Smart Configurator Settings

This procedure is only necessary when migrating a project that uses the Smart Configurator.

When the Smart Configurator opens the configuration file(.scfg) of a migration source project and generates the source code, the project is overwritten to the newly created state. Therefore, a new configuration file for the migration destination device must be created and manually linked to the project.

- (1) Create a configuration file for the migration destination device in the Smart Configurator. See "2.2 Smart Configurator Change Procedure" for details on Smart Configurator settings.
- (2) Delete the Renesas_SC folder and the IAR project connection file(.ipcf) from the project.



Figure 1.23 Smart Configurator Settings (1/5)



RL78 Family How to change devices in the sample project for the DSP Library and the Security Library

(3) Open the project folder in Explorer and replace the src\smc_gen folder with the one generated in step (1).



Figure 1.24 Smart Configurator Settings (2/5)



(4) Link the project to the configuration file created in step (1).

(4)-1 Click [Project] -> [Add Project Connection] to display the Add Project Connection screen.



Figure 1.25 Smart Configurator Settings (3/5)



(4)-2 Select [IAR Project Connection]. Click [OK] to open the Explorer for IAR project connection file selection.

Add Project Cor	nection	×
Connect using:	IAR Project Connection	~
	ОК	Cancel

Figure 1.26 Smart Configurator Settings (4/5)

(4)-3 In the Explorer that appears, select the IAR project connection file(.ipcf) generated in step (1) and click [Open].

Make sure that the Renesas_SC folder and the IAR project connection file(.ipcf) are added to the project.

File Edit View Project Emulator Tools Wind	low H	lelp
i 🗅 🖸 🗳 🚔 🔚 🕹 🖄 🛍 🗂 I D C I 🦳		
Workspace	•	ąχ
Debug		~
Files	•	•
🗆 🌒 sha_rl78_sim_sample - Debug *	~	
📙 🖵 🖬 sha		
│		
		•
🕂 🖵 🛋 Renesas_SC		
L – ⊞ 🛋 smc_gen		•
- Duildinfo.ipcf		
Here 🖬 main.c		•
📙 🖬 main.h		
🖵 🖬 Output		

Figure 1.27 Smart Configurator Settings (5/5)

(5) To configure the settings for "RL78 Family True Random Number Generator (TRNG) Software Driver", make the following changes.

Refer to Config_UART0.c and Config_UART0.h in the src\smc_gen\Config_UART0 folder of the migration source project and add the declaration and definition of the putchar and send functions to any source files.



2. Appendix

2.1 Sample Code Size Adjustment

The sample code included in the migration source project may not be usable as is because the ROM/RAM capacity of the migration destination device is not sufficient. In such cases, please change the sample code to fit into the ROM/RAM capacity of the migration destination device.

Examples can be adjusted in the following ways.

- Leave only the functions you want to check in the sample code.
- Increase the level of compiler optimization.



2.2 Smart Configurator Change Procedure

If your project uses the Smart Configurator, make the following changes in the Smart Configurator.

Please refer to the following document for detailed Smart Configurator operation procedures.

- RL78 Smart Configurator User's Guide: CS+ (R20AN0580)
- RL78 Smart Configurator User's Guide: e² studio (R20AN0579)
- RL78 Smart Configurator User's Guide: IAREW (R20AN0581)

(1) Change the device selected on the [Board] page to the migration destination device.

- (2) Change the settings on the [Clocks] and [System] pages according to the debugging environment.
- Note: When configuring RL78/G15 or RL78/G16 group devices, select a value lower than or equal to the supply voltage of the operating environment for the [Reset generation level(VSDR)] on the [System] page.

ystem configuration			🕤 🚵 Generate Code Generate Repo
2			
• On-chip debug setting			
On-chip debug operation settin	g		
○ Unused	Use emulator	O COM Port	
Emulator setting C E2	• E2 Lite		
Pseudo-RRM/DMM function set	tting Used		
Start/Stop function setting	OUsed		
Monitoring point function settir Unused	-		
Security ID setting Use security ID Security ID	0x000000000000000000000000000000000000	0	
Selectable Power-on-reset Cir	cuit		
RESET pin setting	◯ Used		
Operation mode setting			
Reset generation level(VSDR)	4.20 ~ (V)		
	4.20 2.84 2.52 2.11		
erview Board Clocks System Co	omponents Pins Interrupt		

Figure 2.1 Reset generation level(VSDR) setting

- (3) To configure settings for "RL78/G23 Unique ID Read Driver" and "RL78 Family True Random Number Generator (TRNG) Software Driver" for IAR Embedded Workbench for Renesas RL78, please add UART communication components on the [Components] page. For details on UART communication component settings, please refer to the application notes for the respective middleware.
- (4) On the [Components] page, change the version of the BSP SIS module (r_bsp component) to the version corresponding to the migration destination device.
- (5) Generate source code.



Revision History

		Description		
Rev.	Date	Page	Summary	
1.00	Dec 15, 2022	-	First edition issued.	
1.01	Feb 10, 2023	1	Title changed.	
			Added middleware category to Table 1.	
			Added RL78/G22 to the Target Device.	
		28	 1.3.4 Smart Configurator Settings Added procedures for configuring settings for the "RL78 Family True Random Number Generator (TRNG) Software Driver". 	
		30	2.2 Smart Configurator Change Procedure Added procedures for configuring settings for "RL78/G23 Unique ID Read Driver" and "RL78 Family True Random Number Generator (TRNG) Software Driver" for IAR Embedded Workbench for Renesas RL78.	
1.02	Jun 05, 2023	-	Added RL78/G16 to the Target Device.	
1.03	Aug 01, 2023	-	Added RL78/G24 to the Target Device.	



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

Notice

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
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